

ANTREX Electronics

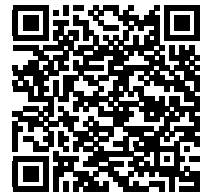
Electronic Components Sourcing Information

Product Reference Information

Part Number:	SSM3K44MFV,L3F
Manufacturer:	Toshiba Semiconductor and Storage
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/toshiba-semiconductor-and-storage-ssm3k44mfv-l3f.html>



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Contact Information

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM3K44MFV

High Speed Switching Applications

Analog Switch Applications

- AEC-Q101 qualified (Note 1)
- Compact package suitable for high-density mounting
- Low ON-resistance : $R_{DS(ON)} = 4.0 \Omega$ (max) (@ $V_{GS} = 4 V$)
: $R_{DS(ON)} = 7.0 \Omega$ (max) (@ $V_{GS} = 2.5 V$)

Note 1: For detail information, please contact to our sales.

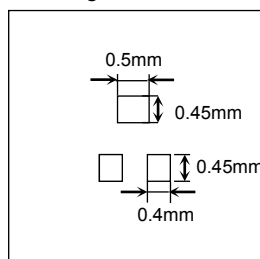
Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DS}	30	V
Gate-source voltage		V_{GS}	± 20	V
Drain current	DC	I_D	100	mA
	Pulse	I_{DP}	200	
Drain power dissipation ($T_a = 25^\circ C$)		P_D (Note 1)	150	mW
Channel temperature		T_{ch}	150	$^\circ C$
Storage temperature		T_{stg}	-55 to 150	$^\circ C$

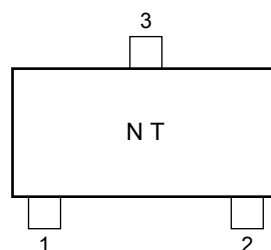
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

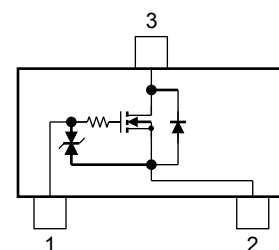
Note 1: Total rating, mounted on FR4 board (25.4 mm $\times$ 25.4 mm $\times$ 1.6 mm)



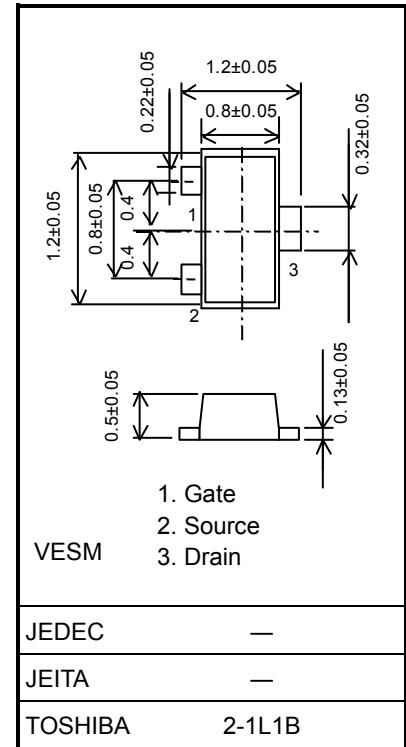
Marking



Equivalent Circuit



Unit: mm



Weight: 1.5 mg (typ.)

Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

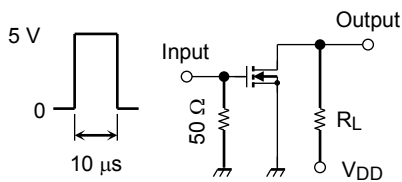
Start of commercial production
2009-12

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	IGSS	VGS = ±14 V, VDS = 0 V	—	—	±1	μA
Drain-source breakdown voltage	V (BR) DSS	ID = 0.1 mA, VGS = 0 V	30	—	—	V
Drain cut-off current	IDSS	VDS = 30 V, VGS = 0 V	—	—	1	μA
Gate threshold voltage	Vth	VDS = 3 V, ID = 0.1 mA	0.8	—	1.5	V
Forward transfer admittance	Yfs	VDS = 3 V, ID = 10 mA	25	—	—	mS
Drain-Source on-resistance	RDS (ON)	ID = 10 mA, VGS = 4 V	—	2.2	4.0	Ω
		ID = 10 mA, VGS = 2.5 V	—	4.0	7.0	
Input capacitance	Ciss	VDS = 3 V, VGS = 0 V, f = 1 MHz	—	8.5	—	pF
Reverse transfer capacitance	Crss		—	5.3	—	
Output capacitance	Coss		—	9.4	—	
Switching time	Turn-on time	VDD = 5 V, ID = 10 mA, VGS = 0 to 5 V	—	50	—	ns
	Turn-off time		—	200	—	

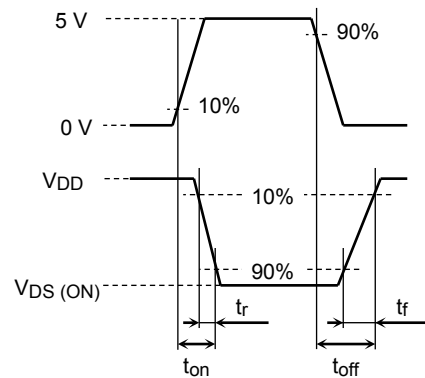
Switching Time Test Circuit

(a) Test circuit



VDD = 5 V
Duty ≤ 1%
Input: tr, tf < 5 ns
(Zout = 50 Ω)
Common Source
Ta = 25°C

(b) VIN



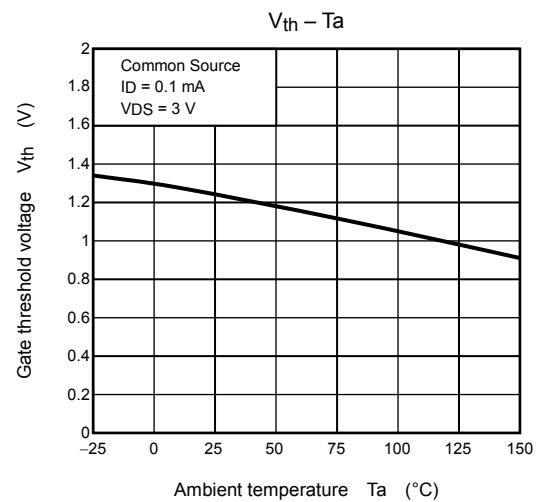
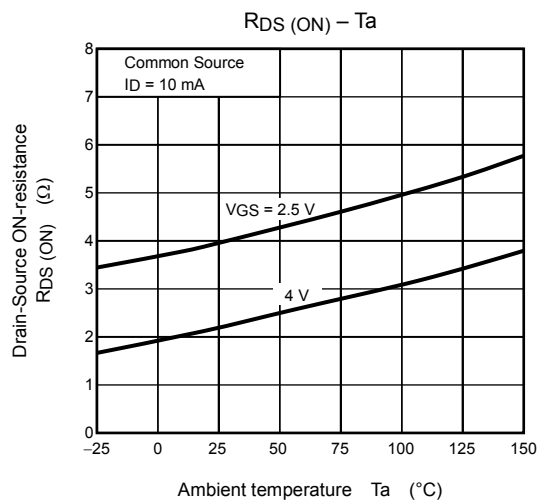
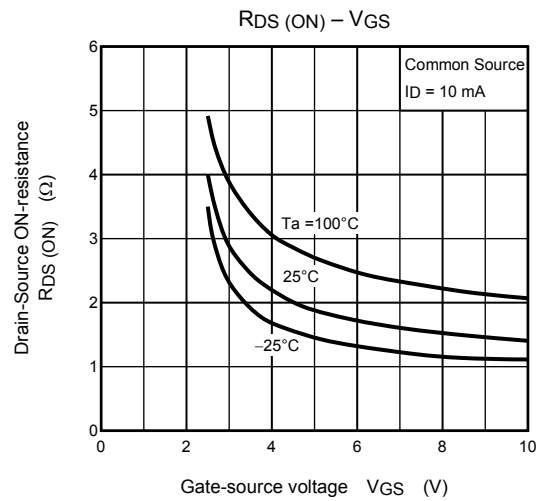
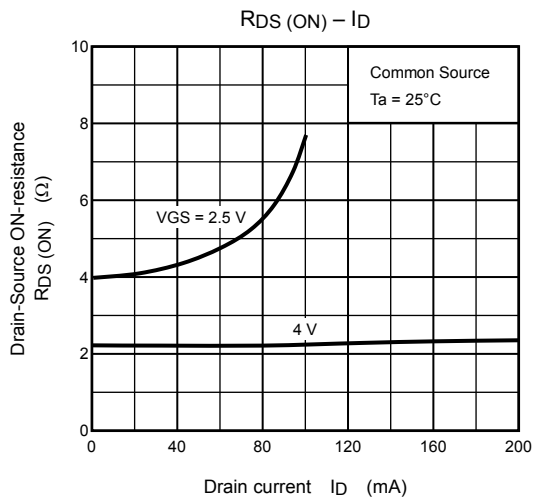
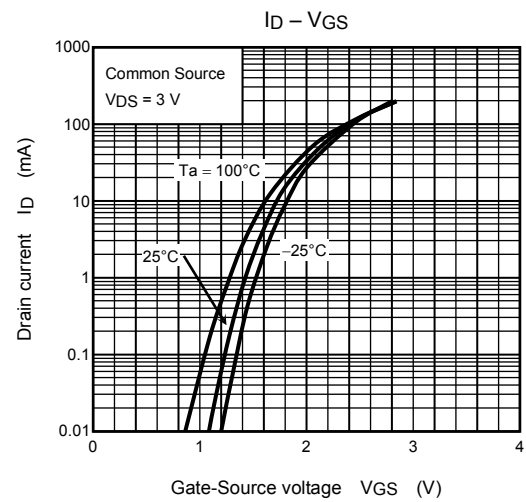
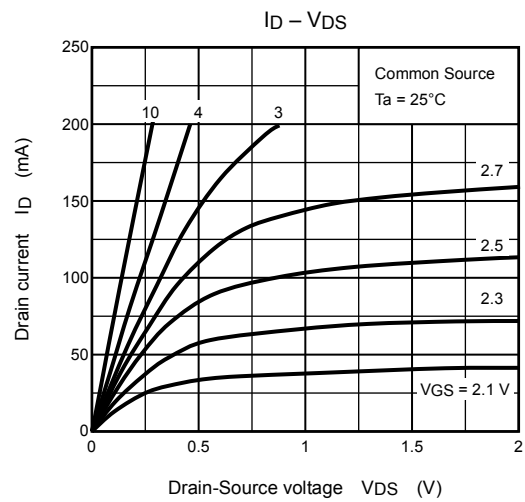
(c) VOUT

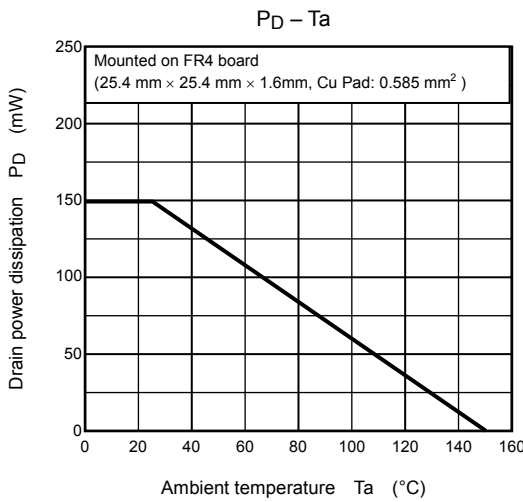
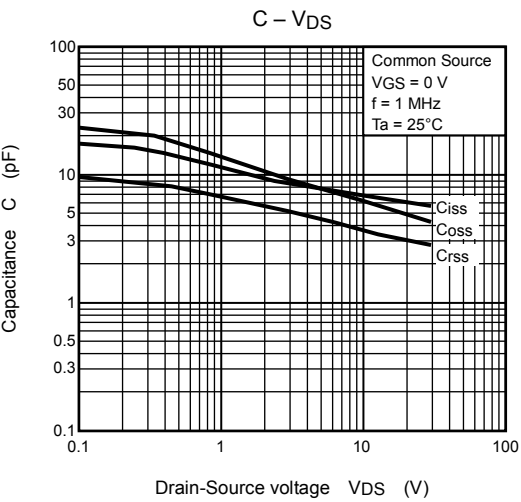
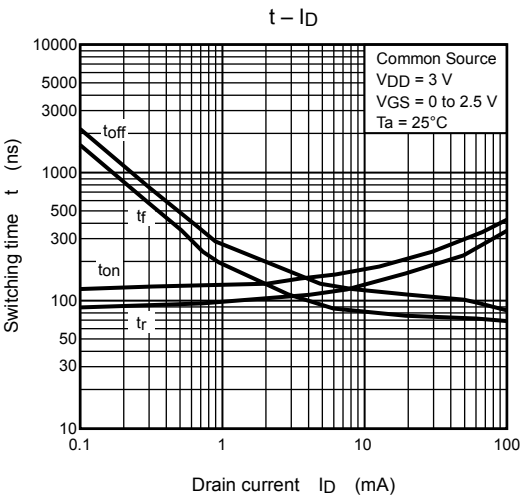
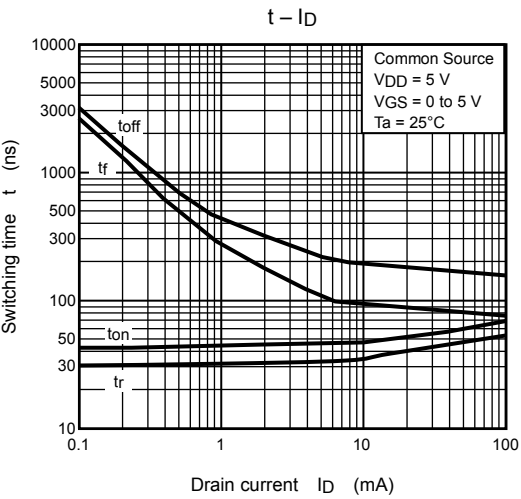
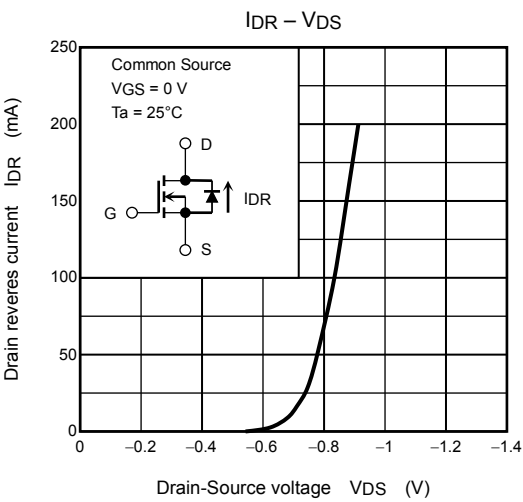
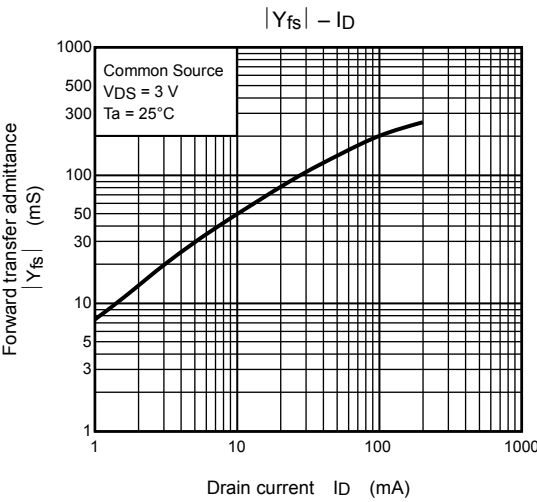
Precaution

Vth can be expressed as the voltage between gate and source when the low operating current value is ID = 100 μA for this product. For normal switching operation, VGS (on) requires a higher voltage than Vth and VGS (off) requires a lower voltage than Vth.

(The relationship can be established as follows: VGS (off) < Vth < VGS (on))

Please take this into consideration when using the device.





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